

IN THE U.S. PATENT AND TRADEMARK OFFICE

December 8, 2008

Applicants: Hironori KOBAYASHI et al

Title: RESIN COMPOSITION

Serial No.: 10/575 336 Group: 1796

Confirmation No.: 1816

Filed: April 7, 2006 Examiner: Dollinger

International Application No.: PCT/JP2004/014814

International Filing Date: September 30, 2004

Atty. Docket No.: 4700.P0326US

Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

Herewith is an amendment in the above-identified application.

- [] Applicant claims small entity status. See 37 CFR 1.27.
- [] The additional filing fee has been calculated as shown below:

	No.	No.	(X)	RATE	()	-	
For	Filed	Extra	LG Entity		SM Entity	Fee)
Total Claims	(10 -	20 = 0)	x \$ 52.00		x \$ 26.00		
Indep. Claims	(1 -	3 = 0)	x \$220.00		x \$110.00		
[] Multiple De	p. Clair	n	+ \$390.00		+ \$195.00		
* * * TOTAL FILING FEE * * *						\$	0.00

- [] Pursuant to 37 CFR 1.136(a), please extend the shortened period for response by month(s). The extension fee is: \$.
- [] A Check for \$ is enclosed to cover fees.
- [X] Please credit any overpayment, or charge any additional filing fee required under 37 CFR 1.16 or 1.17 by this communication, to Deposit Account No. 06-1382.

TFC/smd

Terryence F. Chapman Reg. No. 32 549

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on December 8, 2008.

130.10/08

Terryence F. Chapman